



AO4815

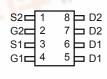
Dual P-Channel Enhancement Mode Field Effect Transistor

General Description

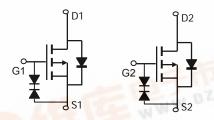
The AO4815 uses advanced trench technology to provide excellent R_{DS(ON)}, and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications. The device is ESD protected. Standard Product AO4815 is Pb-free (meets ROHS & Sony 259 specifications). AO4815L is a Green Product ordering option. AO4815 and AO4815L are electrically identical.

Features

 $V_{DS} (V) = -30V$ $I_{D} = -8A (V_{GS} = -20V)$ $R_{DS(ON)} < 18m\Omega (V_{GS} = -20V)$ $R_{DS(ON)} < 20m\Omega (V_{GS} = -10V)$ ESD Rating: 2KV HBM



SOIC-8



Absolute Maximum Ratings T _A =25°C unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V_{DS}	-30	V				
Gate-Source Voltage		V_{GS}	±25	V				
Continuous Drain	T _A =25°C		-8	一方切門				
Current ^A	T _A =70°C	I _D	-6.9	A.COM				
Pulsed Drain Current ^B		I _{DM}	-40	W. W. DE				
	T _A =25°C	D.	2	W				
Power Dissipation A	T _A =70°C	P _D	1.44	VV				
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C				

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\theta JA}$	50	62.5	°C/W			
Maximum Junction-to-Ambient A	Steady-State	$\Gamma_{\theta JA}$	73	110	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	31	40	°C/W			

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Parameter Conditions		Тур	Max	Units
STATIC F	PARAMETERS					
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =-250μA, V _{GS} =0V	-30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-24V, V _{GS} =0V			-1	
		T _J =55°C	,C		-5	μΑ
I_{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±25V			±1	μА
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=-250\mu A$	-1	-2.8	-3	V
$I_{D(ON)}$	On state drain current	V _{GS} =-10V, V _{DS} =-5V	-40			Α
R _{DS(ON)} Static Drain-Source On-Re		V _{GS} =-20V, I _D =-8A		14.1	18	m()
	Static Drain-Source On-Resistance	T _J =125°	,C	19	24	mΩ
		V_{GS} =-10V, I_D =-8A		16.2	20	mΩ
		V _{GS} =-4.5V, I _D =-5A		37		mΩ
g _{FS}	Forward Transconductance	V_{DS} =-5V, I_D =-8A		15		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V			-1	V
Is	Maximum Body-Diode Continuous Curi			-2.6	Α	
DYNAMIC	PARAMETERS					
C _{iss}	Input Capacitance			2330	2900	pF
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =-15V, f=1MHz		480		pF
C _{rss}	Reverse Transfer Capacitance			320		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		6.8	10	Ω
SWITCHI	NG PARAMETERS	•				
Q_g	Total Gate Charge			41	52	nC
Q_{gs}	Gate Source Charge	V_{GS} =-10V, V_{DS} =-15V, I_{D} =-8A		10		nC
Q_{gd}	Gate Drain Charge			12		nC
t _{D(on)}	Turn-On DelayTime			13		ns
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-15V, R_L =1.8 Ω	2,	12		ns
t _{D(off)}	Turn-Off DelayTime	R_{GEN} =3 Ω		51		ns
t _f	Turn-Off Fall Time			30.5		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-8A, dI/dt=100A/μs		28	35	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =-8A, dI/dt=100A/μs		20.5		nC

A: The value of $R_{0,JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating.

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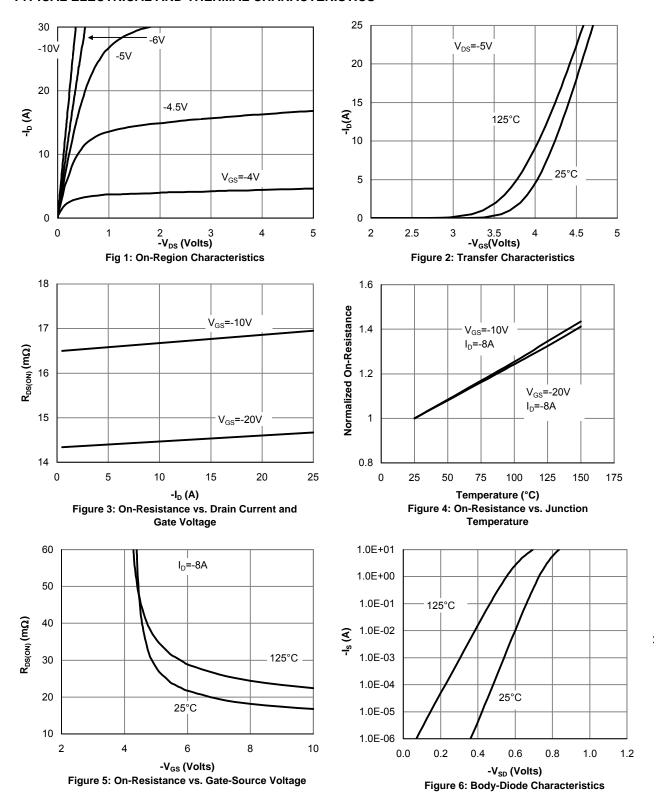
B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

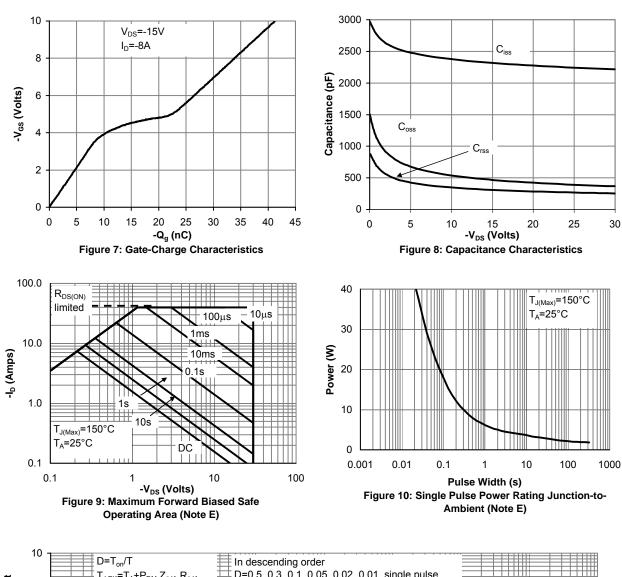
D. The static characteristics in Figures 1 to 6,12,14 are obtained using $80\,\mu s$ pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25 °C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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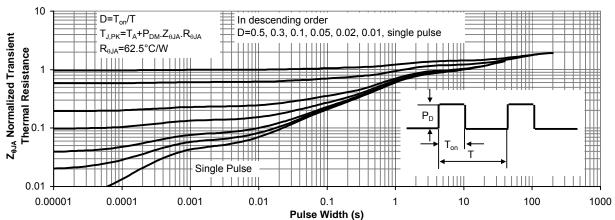


Figure 11: Normalized Maximum Transient Thermal Impedance



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